

INDIAN INSTITUTE OF HARDWARE TECHNOLOGY LTD
312. 3rd Floor, Harshit Corporate, Near Amanaka Flyover, G.E. Road
Raipur - 492 010.(CG) |Tel|: 0711-6513555
wwwiiht.com | Email raipur@iiht.com

MEMORANDUM OF UNDERSTANDING (MoU) UNDER IIIC

BETWEEN

Chouksey Engineering College, LalKhadan, Masturi Road, NH-49, Bilaspur 495004 [C.G.)
imparting and offering educational courses, having its headquarter in Bhopal and being
represented by *Principal- Prof. Dr. K.C. Mahajan*

AND

IIHT Raipur. Address: Indian institute Of Hardware Technology Ltd., Raipur Office:312,3rd
Floor,Harshit Corporate, Near Amanaka Flyover, GE Road, Raipur [C.G.) CIN No.
U85110KA1995PLC018936 Phone: +91-8527289853 / 9516977399 / 0771-6513555 /
6513666 Email: raipur@iiht.co.in, www.iiht.com by *Center manager— Mr. Lagendra Nath.*

OBJECTIVE OF THE AGREEMENT:

To establish a mutually beneficial relationship built on academic, development and
training of students under industry institute interaction Cell. in Areas of
cooperation between the Chouksey Engineering College (hereafter referred to as
CEC) and IIHT Raipur (here after referred to as IIHT).

The Chouksey Engineering College, Bilaspur and IIHT Raipur, enter into a general
agreement of mutually beneficial co-operation for industry institution interaction
Cell. The aim of the co-operation is to maintain permanent contacts between
industry, academic teachers and students, undertake joint actions, promote and
exchange achievements and co-operate in the areas of teaching, science,
research, Certification, internships/ Guest Lectures, Seminars and Higher
Education for students under industry institution interaction Cell.

§ 1

The scope of co-operation between the Parties shall include in particular:

1. Co-operation in improvement of academic teachers, development of contacts
between research staff, including teacher mobility & industry delegate.
2. Co-operation in the updating of students with industry demands.
3. Exchange of experience and information concerning the structure and content
of the Curricula and organization for the teaching processes.
4. Joint organization and carrying out of research and exchange of the results of
research.
5. Exchange of Data, materials, books, periodicals and scientific literature.
6. Exchange of experience in administration and management.
7. Mutual assistance and support for the actions undertaken by both institutions to
participate in teaching and research programs.
8. Exchange of internships / Gust Lectures, Social and cultural exchange of
students.

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9. Mutual assistance and support for National and international level conferences and workshops.

10. It's a Voluntary participation. This is honorary MoU to promote the good institute-industry interaction activity by both with no post of profit or loss.

§2

The co-operation in the areas specified in paragraph 1 of the agreement shall include inparticular:

- 1. Academic exchange, including series of guest lectures, training, as well as research and education fellowships.**
- 2. Organization of seminars, conferences, scientific workshops and training.**
- 3. Joint research, Project Research, Internships, on job Training.**
- 4. Joint scientific and educational publications.**
- 5. Exchange of information concerning opportunities for co-operation.**
- 6. Participation in bilateral and multilateral scientific and educational programs.**

§3

The co-operation is based on the principles of equal treatment and mutual benefit of both CEC and IIHT, with their involvement - respective to their capabilities.

§4

The co-operation is based on the principles of equal treatment and mutual benefit of both CEC and IIHT. By this MOU both the parties will be able to use each other's Mono/Logo, where ever needed for their promotional. And if both want to use any specified Mono/Logo as authorized by any other 3rd party a separate written authorization will be needed to each other.

§5

No financial condition is liable in this MOU. Both the institutions have no involvement of any kind of financial terms and conditions for this MOU.

The financial conditions of the co-operation shall be agreed separately every time for any specific form of co-operation, taking into consideration the financial capabilities of both CEC and IIHT.

§ 6

In order to fulfill the provisions of the Agreement, an annex - subject to approval by the rectors of both institutes, shall be attached to it containing details of the scope and form of the planned co-operation.

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§ 7

1. The MOU Agreement has been made for Five Years.
2. Each Party has the right to terminate the Agreement with a one month notice period.

§8

1. Any changes in the Agreement shall be null and void unless made in writing.
2. Any dispute arising from this agreement does not confer on any party the right to enforce it in Court of law but to resolve it through a conciliator appointed and accepted by both parties
3. Both the parties will maintain each other's standard levels, and not involve each other in any kind of frauds, Criminal and below Social standard works which manipulates name of other institution.

§ 9

The agreement was made in English, in two identical copies in language, one for each Party.

As signed and agree upon by: I certify that I have read, understood and have received a copy of this Memorandum of Understanding.


Chouksey Engineering College,
Bilaspur.
Signature and date:
04.03.2021




Interbiz consulting USA
Bilaspur.
Signature and Date:
04.03.2021

